## SN54LVTH240, SN74LVTH240 3.3-V ABT OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS <br> SCBS679E - DECEMBER 1996 - REVISED APRIL 1999

- State-of-the-Art Advanced BiCMOS

Technology (ABT) Design for 3.3-V Operation and Low Static-Power Dissipation

- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V VCC)
- Support Unregulated Battery Operation Down to 2.7 V
- Typical Volp (Output Ground Bounce) $<0.8 \mathrm{~V}$ at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
- $\mathrm{I}_{\text {off }}$ and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ( $\mathrm{C}=200 \mathrm{pF}, \mathrm{R}=0$ )
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), and Ceramic (J) DIPs


## description

These octal buffers and line drivers are designed specifically for low-voltage $(3.3-\mathrm{V}) \mathrm{V}_{\mathrm{CC}}$ operation, but with the capability to provide a TTL interface to a $5-\mathrm{V}$ system environment.
These devices are organized as two 4-bit buffer/line drivers with separate output-enable ( $\overline{\mathrm{OE}})$ inputs. When $\overline{\mathrm{OE}}$ is low, the devices pass data from the A inputs to the Y outputs. When $\overline{\mathrm{OE}}$ is high, the outputs are in the high-impedance state.
Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.
When $\mathrm{V}_{\mathrm{CC}}$ is between 0 and 1.5 V , the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V , $\overline{\mathrm{OE}}$ should be tied to $\mathrm{V}_{\mathrm{CC}}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using $\mathrm{I}_{\text {off }}$ and power-up 3-state. The $\mathrm{I}_{\text {off }}$ circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.
The SN54LVTH240 is characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The SN74LVTH240 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

FUNCTION TABLE
(each buffer)

| INPUTS |  | OUTPUT |
| :---: | :---: | :---: |
| $\overline{\mathrm{OE}}$ | $\mathbf{A}$ |  |
| L | $H$ | L |
| L | L | H |
| $H$ | $X$ | $Z$ |

logic symbol $\dagger$

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
logic diagram (positive logic)


## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$

| Supply voltage range, $\mathrm{V}_{\mathrm{CC}} \ldots \ldots$. |  |
| :---: | :---: |
| Input voltage range, $\mathrm{V}_{\text {I }}$ (see Note 1) | -0.5 V to 7 V |
| Voltage range applied to any output in the high-impedance or power-off state, $\mathrm{V}_{\mathrm{O}}$ (see Note 1) |  |
| Voltage range applied to any output in the high state, $\mathrm{V}_{\mathrm{O}}$ (see Note 1 ) $\ldots \ldots \ldots \ldots . .0 .5 \mathrm{l}$, to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ |  |
|  |  |
| SN74LVTH240 | 128 mA |
| Current into any output in the high state, $\mathrm{I}_{\mathrm{O}}$ (see Note 2): SN54LVTH240 ...................... 48 mA |  |
| SN74LVTH240 | 64 mA |
|  |  |
|  |  |
| Package thermal impedance, $\theta_{\text {JA }}$ (see Note 3): | $115^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | $97^{\circ} \mathrm{C} / \mathrm{W}$ |
| PW package | $128^{\circ} \mathrm{C} / \mathrm{W}$ |
| Storage temperature range, $\mathrm{T}_{\text {stg }}$ | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |

$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This current flows only when the output is in the high state and $\mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{CC}}$.
3. The package thermal impedance is calculated in accordance with JESD 51.
recommended operating conditions (see Note 4)

|  |  |  | SN54LVTH240 |  | SN74LVTH240 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 2.7 | 3.6 | 2.7 | 3.6 | V |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage |  | 2 |  | 2 |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  | 0.8 |  | 0.8 | V |
| $\mathrm{V}_{1}$ | Input voltage |  |  | 5.5 |  | 5.5 | V |
| ${ }^{\mathrm{IOH}}$ | High-level output current |  |  | -24 |  | -32 | mA |
| IOL | Low-level output current |  |  | 48 |  | 64 | mA |
| $\Delta t / \Delta v$ | Input transition rise or fall rate | Outputs enabled |  | 10 |  | 10 | ns/V |
| $\Delta \mathrm{t} / \Delta \mathrm{V}_{\mathrm{CC}}$ | Power-up ramp rate |  | 200 |  | 200 |  | $\mu \mathrm{s} / \mathrm{V}$ |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperature |  | -55 | 125 | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |

NOTE 4: All unused control inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)


* On products compliant to MIL-PRF-38535, this parameter is not production tested.
$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$\ddagger$ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.
$\S$ This is the increase in supply current for each input that is at the specified TTL voltage level rather than $V_{C C}$ or GND.
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | то (OUTPUT) | SN54LVTH240 |  |  |  | SN74LVTH240 |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  | $\begin{gathered} \hline \mathrm{VCC}=3.3 \mathrm{~V} \\ \pm 0.3 \mathrm{~V} \end{gathered}$ |  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  |  |
|  |  |  | MIN | MAX | MIN | MAX | MIN | TYP $\dagger$ | MAX | MIN | MAX |  |
| tPLH | A | Y | 0.9 | 4.3 |  | 5.1 | 1.1 | 2.2 | 3.8 |  | 4.6 | ns |
| tPHL |  |  | 1.2 | 4.7 |  | 4.9 | 1.3 | 2.6 | 4 |  | 4.2 |  |
| tPZH | $\overline{\mathrm{OE}}$ | Y | 1 | 5.7 |  | 6.7 | 1.1 | 2.6 | 4.6 |  | 5.6 | ns |
| tPZL |  |  | 1.2 | 5.5 |  | 6.2 | 1.4 | 2.7 | 4.4 |  | 5 |  |
| tPHZ | $\overline{\mathrm{OE}}$ | Y | 1 | 5.1 |  | 5.2 | 2 | 2.9 | 4.4 |  | 4.6 | ns |
| tplZ |  |  | 1.1 | 5.4 |  | 5.4 | 1.8 | 3 | 4.3 |  | 4.3 |  |

$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## PARAMETER MEASUREMENT INFORMATION



| TEST | S1 |
| :---: | :---: |
| tPLH/tPHL | Open |
| tPLZ/tPZL | 6 V |
| tPHZ/tPZH | GND |



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES

VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS


NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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